

**IN THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application.

1. (Previously presented) A flame retardant resin composition comprising:

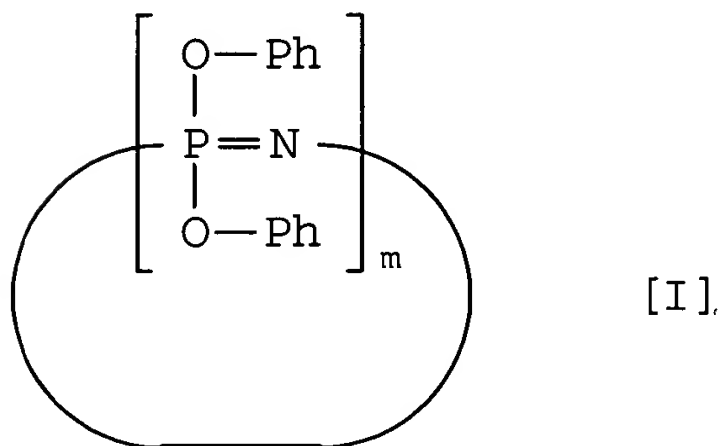
100 parts by weight of a thermoplastic polyamide resin (A),

1 to 100 parts by weight of a phosphazene compound (C), and

a phosphazene compatibility enhancing resin (B), consisting essentially of a polyphenylene ether-based resin, or a mixture of a polyphenylene ether-based resin and a polystyrene based resin being present in an amount of 10 to 500% by weight based on the weight of said phosphazene compound (C).

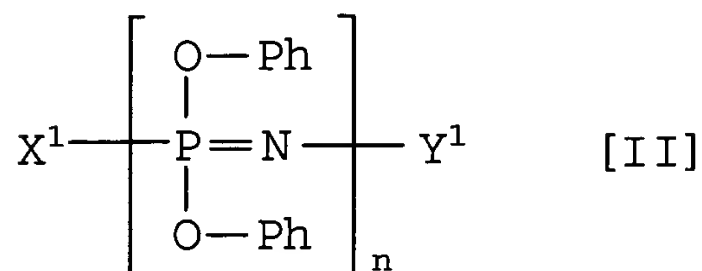
2. (Original) A flame retardant resin composition according to claim 1, wherein the phosphazene compound (C) comprises at least one compound selected from the group consisting of:

cyclic phenoxy phosphazenes represented by the general formula [I]:



wherein m is an integer of 3 to 25 and Ph is phenyl;

chain phenoxy phosphazenes represented by the general formula [II]:

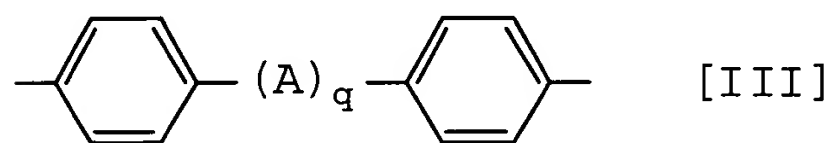


wherein  $X^1$  is  $-\text{N}=\text{P}(\text{OPh})_3$  or  $-\text{N}=\text{P}(\text{O})\text{OPh}$ ,  $Y^1$  is  $-\text{P}(\text{OPh})_4$  or  $-\text{P}(\text{O})\text{OPh}_2$ ,  $n$  is an integer of 3 to 10,000, and Ph is phenyl; and

cross-linked phenoxy phosphazene compounds obtained by cross-linking at least one phenoxy phosphazene selected from the group consisting of those represented by the above general formulae [I] and [II] through a cross-linking group.

3. (Original) A flame retardant resin composition according to claim 2, wherein the cross-linking group is phenylene or bisphenylene.

4. (Original) A flame retardant resin composition according to claim 2, wherein the cross-linking group is at least one group selected from the group consisting of o-phenylene, m-phenylene, p-phenylene, and bisphenylenes represented by the general formula [III]:



wherein A is  $-\text{C}(\text{CH}_3)_2-$ ,  $-\text{SO}_2-$ ,  $-\text{S}-$  or  $-\text{O}-$ ; and  $q$  is 0 or 1.

5. (Original) A flame retardant resin composition according to claim 2, wherein said cross-linked phenoxy phosphazene compound comprises a cross-linking group which is present between two oxygen atoms of the phenoxy phosphazenes from which phenyl groups are eliminated; contains phenylene groups derived from those represented by the general formula [III] in an amount of 50 to 99.9 mol% based on the total number of phenyl groups and phenylene groups contained in the cyclic phenoxy phosphazene represented by the general formula [I], the

chain phenoxy phosphazene represented by the general formula [II] or mixture thereof; and has no free hydroxy group in a molecule of the phosphazene compound (C).

6. (Original) A flame retardant resin composition according to claim 1, wherein the polyamide resin (A) is polyamide 6.

7. (Original) A flame retardant resin composition according to claim 1, further comprising an inorganic filler (D1).

8. (Original) A flame retardant resin composition according to claim 7, wherein the inorganic filler (D1) is a glass fiber.

9. (Original) A flame retardant resin composition according to claim 7, wherein the content of the inorganic filler (D1) is 5 to 300 parts by weight based on 100 parts of the polyamide resin (A).

10. (Original) A flame retardant resin composition according to claim 1, further comprising a magnetic powder (D2).

11. (Original) A flame retardant resin composition according to claim 10, wherein the content of the magnetic powder (D2) is 50 to 95% by weight based on the weight of the flame retardant resin composition, and the content of the phosphazene compound (C) is 0.1 to 40% by weight based on the weight of the flame retardant resin composition.

12. (Original) A flame retardant resin composition according to claim 10, wherein the magnetic powder (D2) is ferrite-based magnetic powder, alnico-based magnetic powder or mixture thereof.

13. (Original) A flame retardant resin magnet comprising the flame retardant resin composition according to claim 10.

14. (Previously presented) A flame retardant resin composition comprising:

100 parts by weight of a thermoplastic polyamide resin (A),

1 to 100 parts by weight of a phosphazene compound (C), and

an anti-bleedout resin (B) comprising a polyphenylene ether-based resin, a polystyrene-based resin or mixture thereof, the anti-bleedout resin being present in an amount of 10 to 500% by weight based on the weight of said phosphazene compound (C),

resin pellets comprising said flame retardant resin composition being producible by extruding of said flame retardant resin composition by using a twin-screw extruder at 270 °C without bleed-out of phosphazene compound (C).

15. (Currently amended) A flame retardant resin composition comprising:

100 parts by weight of a thermoplastic polyamide resin (A),

1 to 100 parts by weight of a phosphazene compound (C), and

a phosphazene compatibility enhancing resin (B), consisting essentially of a polyphenylene ether-based resin, or a mixture of a polyphenylene ether-based resin and a polystyrene based resin being present in an amount of 10 to 500% by weight based on the weight of said phosphazene compound (C),

further comprising an inorganic filler (D1),

wherein the inorganic filler (D1) is a glass fiber, and

~~A flame retardant resin composition according to claim 8, wherein the glass fiber is surface-treated with a silane-based coupling agent.~~

16. (Currently amended) A flame retardant resin composition comprising:

100 parts by weight of a thermoplastic polyamide resin (A),

1 to 100 parts by weight of a phosphazene compound (C), and  
a phosphazene compatibility enhancing resin (B), consisting essentially of a  
polyphenylene ether-based resin, or a mixture of a polyphenylene ether-based resin and a  
polystyrene based resin being present in an amount of 10 to 500% by weight based on the weight  
of said phosphazene compound (C).

~~A flame retardant resin composition according to claim 1,~~ wherein, the polyphenylene ether-based resin (B) is modified with  $\alpha,\beta$ -unsaturated carboxylic acid.